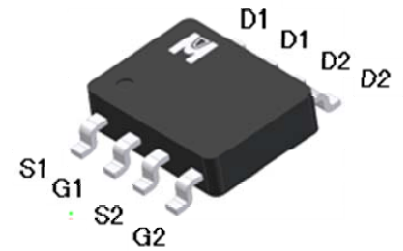
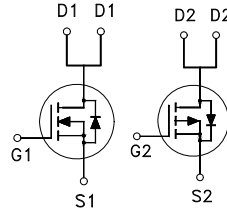


N & P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

| | N-CH | P-CH |
|---------------------|--------------|--------------|
| BV_{DSS} | 30V | -30V |
| $R_{DS(on) (MAX.)}$ | 32m Ω | 40m Ω |
| I_D | 6.5A | -6A |



Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | SYMBOL | LIMITS | | UNIT | |
|--|------------------|---------------------------|------------------|------------------|---|
| | | N-CH | P-CH | | |
| Gate-Source Voltage | V_{GS} | N-CH ± 20 | P-CH ± 20 | V | |
| Continuous Drain Current | I_D | $T_A = 25^\circ\text{C}$ | 6.5 | -6 | A |
| | | $T_A = 100^\circ\text{C}$ | 5.5 | -5 | |
| Pulsed Drain Current ¹ | I_{DM} | 26 | -24 | | |
| Power Dissipation | P_D | $T_A = 25^\circ\text{C}$ | 2 | | W |
| | | $T_A = 100^\circ\text{C}$ | 0.8 | | |
| Operating Junction & Storage Temperature Range | T_{j}, T_{stg} | -55 to 150 | | $^\circ\text{C}$ | |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | SYMBOL | TYPICAL | MAXIMUM | UNIT |
|----------------------------------|-----------------|---------|---------|-----------------------------|
| Junction-to-Case | $R_{\theta JC}$ | | 25 | $^\circ\text{C} / \text{W}$ |
| Junction-to-Ambient ³ | $R_{\theta JA}$ | | 62.5 | |

¹Pulse width limited by maximum junction temperature.

²Duty cycle $\leq 1\%$

³62.5 $^\circ\text{C} / \text{W}$ when mounted on a 1 in² pad of 2 oz copper.



ELECTRICAL CHARACTERISTICS ($T_c = 25\text{ }^\circ\text{C}$, Unless Otherwise Noted)

| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNIT |
|---|---------------|--|--------|------|------|-----------|
| | | | MIN | TYP | MAX | |
| STATIC | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$ $V_{GS} = 0V, I_D = -250\mu A$ | N-CH | 30 | | V |
| | | | P-CH | -30 | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ $V_{DS} = V_{GS}, I_D = -250\mu A$ | N-CH | 1.0 | 1.5 | 3.0 |
| | | | P-CH | -1.0 | -1.5 | -3.0 |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0V, V_{GS} = \pm 20V$ $V_{DS} = 0V, V_{GS} = \pm 20V$ | N-CH | | | ± 100 |
| | | | P-CH | | | ± 100 |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 24V, V_{GS} = 0V$ $V_{DS} = -24V, V_{GS} = 0V$ | N-CH | | | 1 |
| | | | P-CH | | | -1 |
| | | | N-CH | | | 25 |
| | | | P-CH | | | -25 |
| On-State Drain Current ¹ | $I_{D(ON)}$ | $V_{DS} = 5V, V_{GS} = 10V$ $V_{DS} = -5V, V_{GS} = -10V$ | N-CH | 6.5 | | A |
| | | | P-CH | -6 | | |
| Drain-Source On-State Resistance ¹ | $R_{DS(ON)}$ | $V_{GS} = 10V, I_D = 6.5A$ $V_{GS} = -10V, I_D = -6A$ $V_{GS} = 4.5V, I_D = 5.5A$ $V_{GS} = -4.5V, I_D = -5A$ | N-CH | | 28 | 32 |
| | | | P-CH | | 35 | 40 |
| | | | N-CH | | 50 | 60 |
| | | | P-CH | | 55 | 65 |
| Forward Transconductance ¹ | g_{fs} | $V_{DS} = 5V, I_D = 6.5A$ $V_{DS} = -5V, I_D = -6A$ | N-CH | | 14 | S |
| | | | P-CH | | 16 | |
| DYNAMIC | | | | | | |
| Input Capacitance | C_{iss} | N-CH $V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$ P-CH $V_{GS} = 0V, V_{DS} = -15V, f = 1MHz$ | N-CH | | 323 | pF |
| Output Capacitance | C_{oss} | | P-CH | | 820 | |
| | | | N-CH | | 75 | |
| Reverse Transfer Capacitance | C_{rss} | | P-CH | | 122 | |
| | | | N-CH | | 53 | |
| | | | P-CH | | 97 | |



| | | | | | | | | | |
|---|--------------|---|---|------|-----|------|------|---|----|
| Total Gate Charge ^{1,2} | Q_g | N-CH $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 6.5A$ P-CH $V_{DS} = -15V, V_{GS} = -10V,$ $I_D = -6A$ | N-CH | | 7.1 | | nC | | |
| Gate-Source Charge ^{1,2} | Q_{gs} | | P-CH | | 9 | | | | |
| Gate-Drain Charge ^{1,2} | Q_{gd} | | N-CH | | 1.1 | | | | |
| | | | P-CH | | 2.2 | | | | |
| Turn-On Delay Time ^{1,2} | $t_{d(on)}$ | | N-CH $V_{DS} = 10V,$ $I_D = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$ P-CH $V_{DS} = -10V,$ $I_D = -1A, V_{GS} = -10V, R_{GS} = 6\Omega$ | N-CH | | 8 | | | nS |
| | | | | P-CH | | 10 | | | |
| Rise Time ^{1,2} | t_r | N-CH | | | 12 | | | | |
| | | P-CH | | | 15 | | | | |
| Turn-Off Delay Time ^{1,2} | $t_{d(off)}$ | N-CH | | | 28 | | | | |
| | | P-CH | | | 28 | | | | |
| Fall Time ^{1,2} | t_f | N-CH | | 15 | | | | | |
| | | P-CH | | 15 | | | | | |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_c = 25^\circ C$) | | | | | | | | | |
| Continuous Current | I_S | | N-CH | | | 2.3 | A | | |
| | | | P-CH | | | -2.3 | | | |
| Pulsed Current ³ | I_{SM} | | N-CH | | | 9.2 | | | |
| | | | P-CH | | | -9.2 | | | |
| Forward Voltage ¹ | V_{SD} | | $I_F = I_S, V_{GS} = 0V$ | N-CH | | | 1.3 | V | |
| | | | | P-CH | | | -1.3 | | |

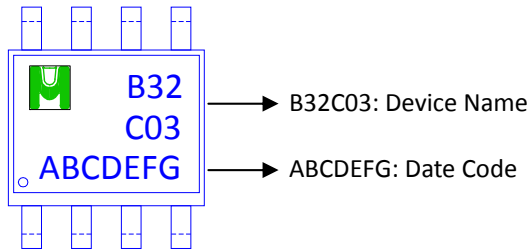
¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

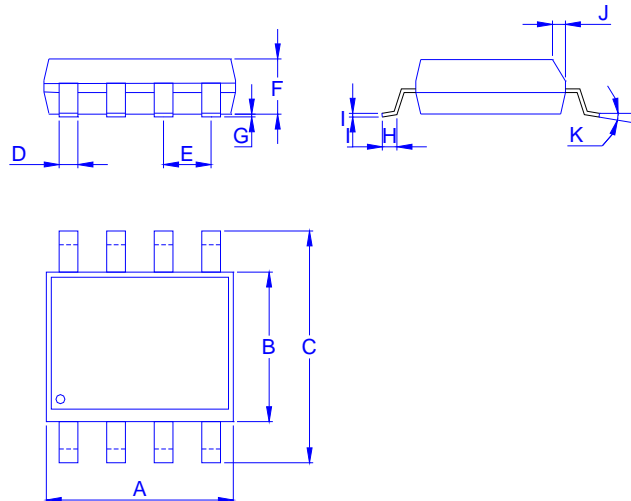
³Pulse width limited by maximum junction temperature.

Ordering & Marking Information:

Device Name: EMB32C03G for SOP-8



Outline Drawing

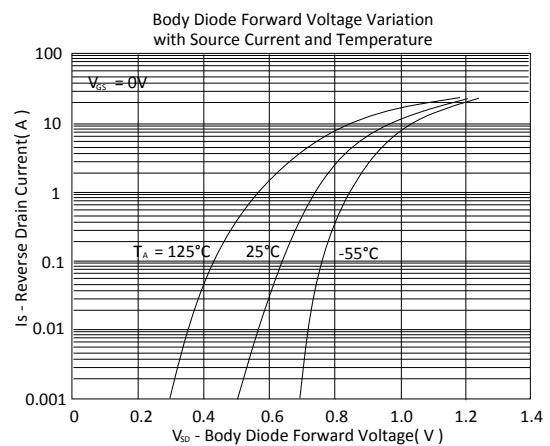
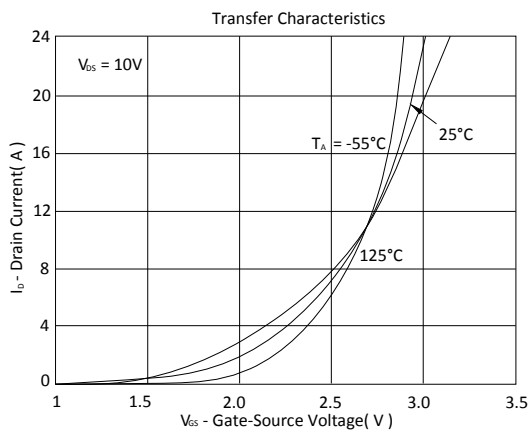
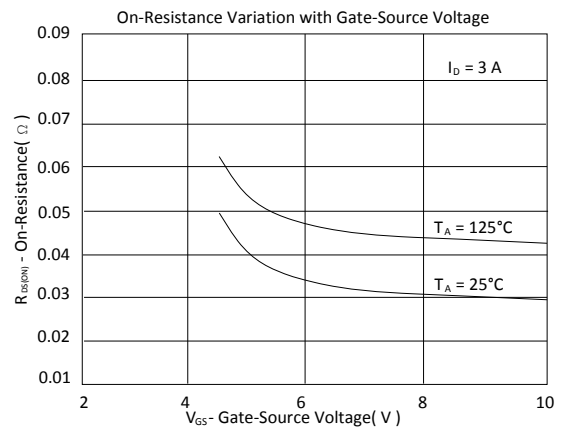
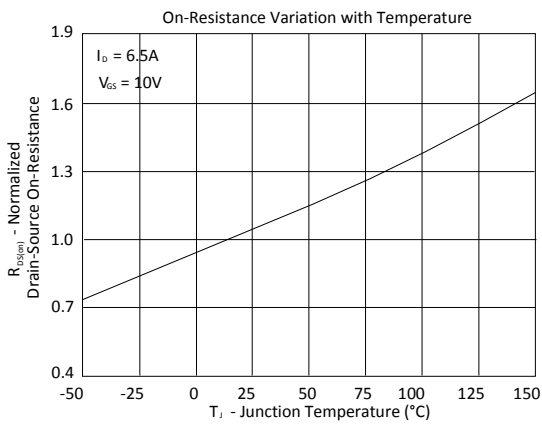
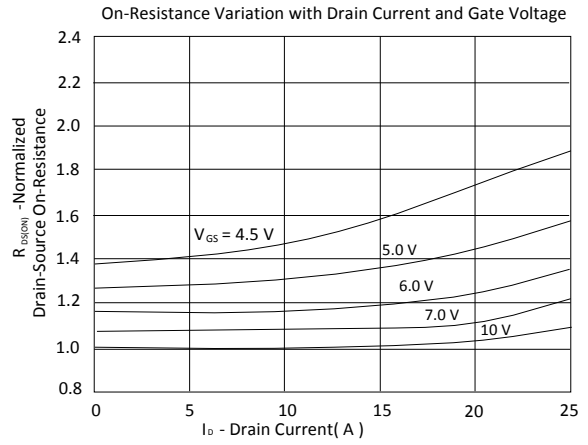
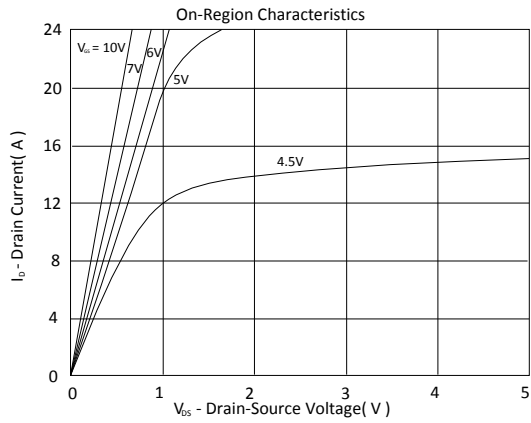


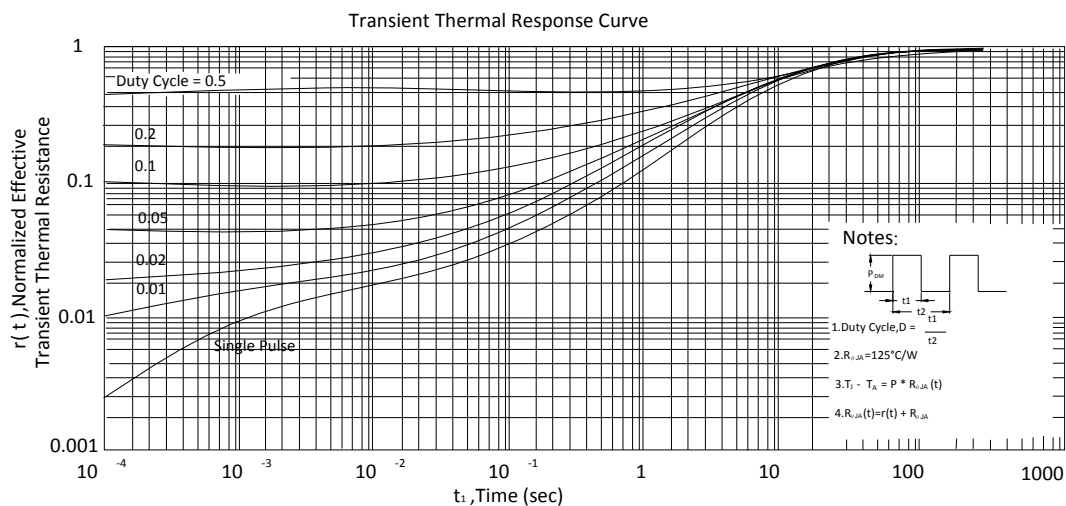
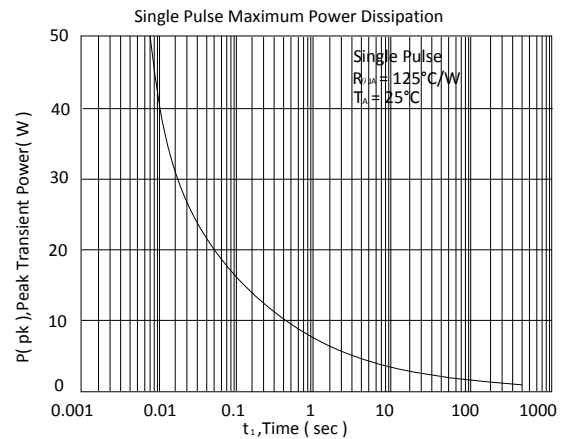
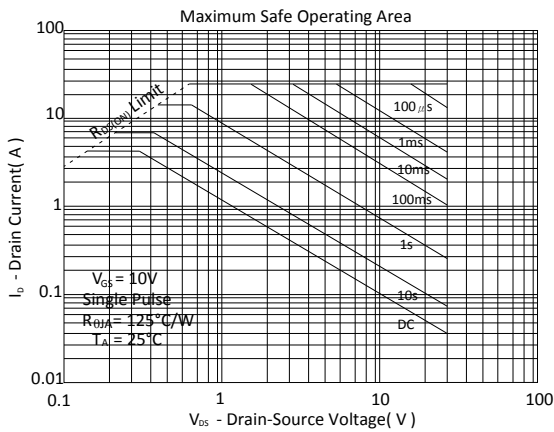
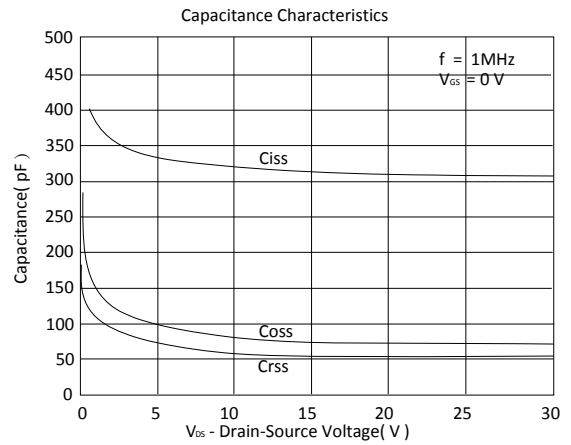
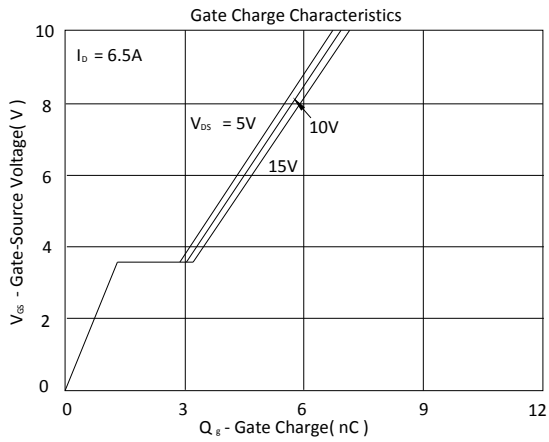
Dimension in mm

| Dimension | A | B | C | D | E | F | G | H | I | J | K |
|-----------|------|------|------|------|------|------|------|------|------|------|----|
| Min. | 4.70 | 3.70 | 5.80 | 0.33 | | 1.20 | 0.08 | 0.40 | 0.19 | 0.25 | 0° |
| Typ. | | | | | 1.27 | | | | | | |
| Max. | 5.10 | 4.10 | 6.20 | 0.51 | | 1.62 | 0.28 | 0.83 | 0.26 | 0.50 | 8° |



N-Channel







P-Channel

